

ThunderLAN™ TNETE100PM PCI ETHERNET™ CONTROLLER WITH POWER MANAGEMENT SINGLE-CHIP 10 BASE-T WITH MII FOR 100 BASE-VG-AnyLAN

SPWS026 – OCTOBER 1996

- Single-Chip Ethernet™ Controller for the Peripheral Component Interconnect (PCI) Local Bus
 - 32-Bit PCI† Glueless Host Interface
 - Compliant With PCI Local-Bus Specification (Revision 2.1)
 - 0-MHz to 33-MHz Operation
 - 3-V or 5-V I/O Operation
 - Adaptive Performance Optimization™ (APO) by Texas Instruments (TI™) for Highest Available PCI Bandwidth
 - High-Performance Bus Master Architecture With Byte-Aligning Direct Memory Access (DMA) Controller for Low Host CPU and Bus Utilization
 - Plug-and-Play Compatible
- Supports 32-Bit Data Streaming on PCI Bus
 - Time-Division Multiplexed Static Random-Access Memory (SRAM)
 - 2-Gbps Internal Bandwidth
- Driver Compatible With All Previous ThunderLAN™ Components
- Switched-Ethernet Compatible
- Full-Duplex Compatible
 - Independent Transmit and Receive Channels
 - Two Transmit Channels for Demand Priority
- Supports Multiple Protocols With a Single Driver Suite Optimized Shared Interrupts
- No On-Board Memory Required
- Auto-Negotiation (N-Way) Compatible
- Multimedia-Ready Architecture
- Supports the Card-Bus Card Information Structure (CIS) Pointer Register
- Early-Receive-Interrupt Count Register
- EEPROM Interface Supports Jumperless Design and Autoconfiguration
- Hardware Statistics Registers for Management-Information Base (MIB)
- Desktop Management Task Force (DMTF) Compatible
- Integrated 10 Base-T, and 10 Base-5 Attachment Unit Interface (AUI) Physical Layer Interface
 - Single-Chip IEEE 802.3 and Blue Book Ethernet-Compliant Solution
 - DSP-Based Digital Phase-Locked Loop
 - Smart Squelch Allows for Transparent Link Testing
 - Transmission Waveshaping
 - Autopolarity (Reverse Polarity Correction)
 - External/Internal Loopback Including Twisted Pair and AUI
 - 10 Base-2 Supported Through AUI Interface
- Media-Independent Interface (MII) for Connecting 100-Mbps External Transceivers
 - Compliant MII for IEEE 802.3u Transceivers
 - Supports 100 Base-TX, 100 Base-T4, 100 Base-FX
 - Super Set Supports IEEE 802.12 Transceivers
 - Supports Ethernet and Token-Ring Framing Formats for 100VG-AnyLAN
 - Link-Pulse Detection for Determining Wire Rate
- Low-Power CMOS Technology – Green PC Compatible
- Magic Packet™ Remote Wake-Up Scheme
- Microsoft™ Advanced Power Management
 - PCI Specification Compatible for Low Power/Sleep Mode
 - Advanced Configuration and Power Interface (ACPI)
- IEEE Standard 1149.1‡ Test-Access Port (JTAG)
- 144-Pin Thin Quad Flat Packages and Quad Flat Packages (PCM and PGE)



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† The PCI Local-Bus Specification, Revision 2.1 should be used as a reference with this document.

‡ IEEE Standard 1149.1-1990, IEEE Standard Test-Access Port and Boundary-Scan Architecture

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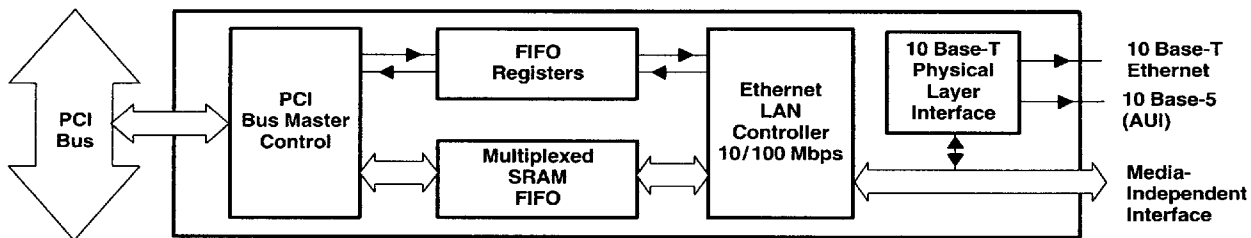


Figure 1. ThunderLAN Architecture

description

ThunderLAN is a high-speed networking architecture that provides a complete PCI-to-10 Base-T/AUI Ethernet solution with the flexibility to handle 100-Mbps Ethernet protocols as networking demands grow.

The TNETE100PM, an implementation of the ThunderLAN architecture (see Figure 1), is an intelligent-protocol network interface. The ThunderLAN SRAM FIFO-based architecture eliminates the need for external memory and offers a single-chip glueless PCI-to-10 Base-T/AUI (IEEE 802.3) solution with an on-board physical layer interface. Modular support for 100 Base-T (IEEE 802.3u) and 100VG-AnyLAN (IEEE 802.12) is provided by a superset of the industry-standard media-independent interface (MII). ThunderLAN uses a single driver suite to support multiple networking protocols.

The glueless PCI interface supports 32-bit streaming, operates at speeds up to 33 MHz, and is capable of internal data-transfer rates up to 2 Gbps, taking full advantage of all available PCI bandwidth. The TNETE100PM offers jumperless autoconfiguration using PCI configuration read/write cycles. Customizable configuration registers, which can be autoloaded from an external serial EEPROM, allow designers of TNETE100PM-based systems to give their systems a unique identification code. The TNETE100PM PCI interface, developed in conjunction with other leaders in the semiconductor and computer industries, has been tested vigorously on multiple platforms to ensure compatibility across a wide array of available PCI products. In addition, the ThunderLAN drivers and ThunderLAN architecture use TI's patented Adaptive Performance Optimization (APO) technology to adjust critical parameters for minimum latency dynamically, minimum host CPU utilization, and maximum system performance. This technology ensures that the maximum capabilities of the PCI interface are used by automatically tuning the controller to the specific system in which it is operating.

The MII, an industry-standard interface for connecting a variety of external IEEE 802.3u physical layer interfaces, is supported fully by the TNETE100PM. In addition, the TNETE100PM features an IEEE 802.12-compliant superset of the MII to allow for support of 100VG-AnyLAN physical layer interfaces. This allows TNETE100PM-based systems to support 100 Base-TX, 100 Base-FX, 100 Base-T4, and 100VG-AnyLAN cabling schemes for maximum flexibility as each new physical layer interface becomes available in the marketplace.

An intelligent protocol handler (PH) implements the serial protocols of the network. The PH is designed for minimum overhead related to multiple protocols, using common state machines to implement 95% of the total protocol handler. On transmit, the PH serializes data, adds framing and cyclic redundancy check (CRC) fields, and interfaces to the network physical layer (PHY) chip. On receive, it provides address recognition, CRC and error-checking, frame disassembly, and deserialization. Data for multiple channels is passed to and from the PH by way of circular-buffer FIFOs in the FIFO SRAM.

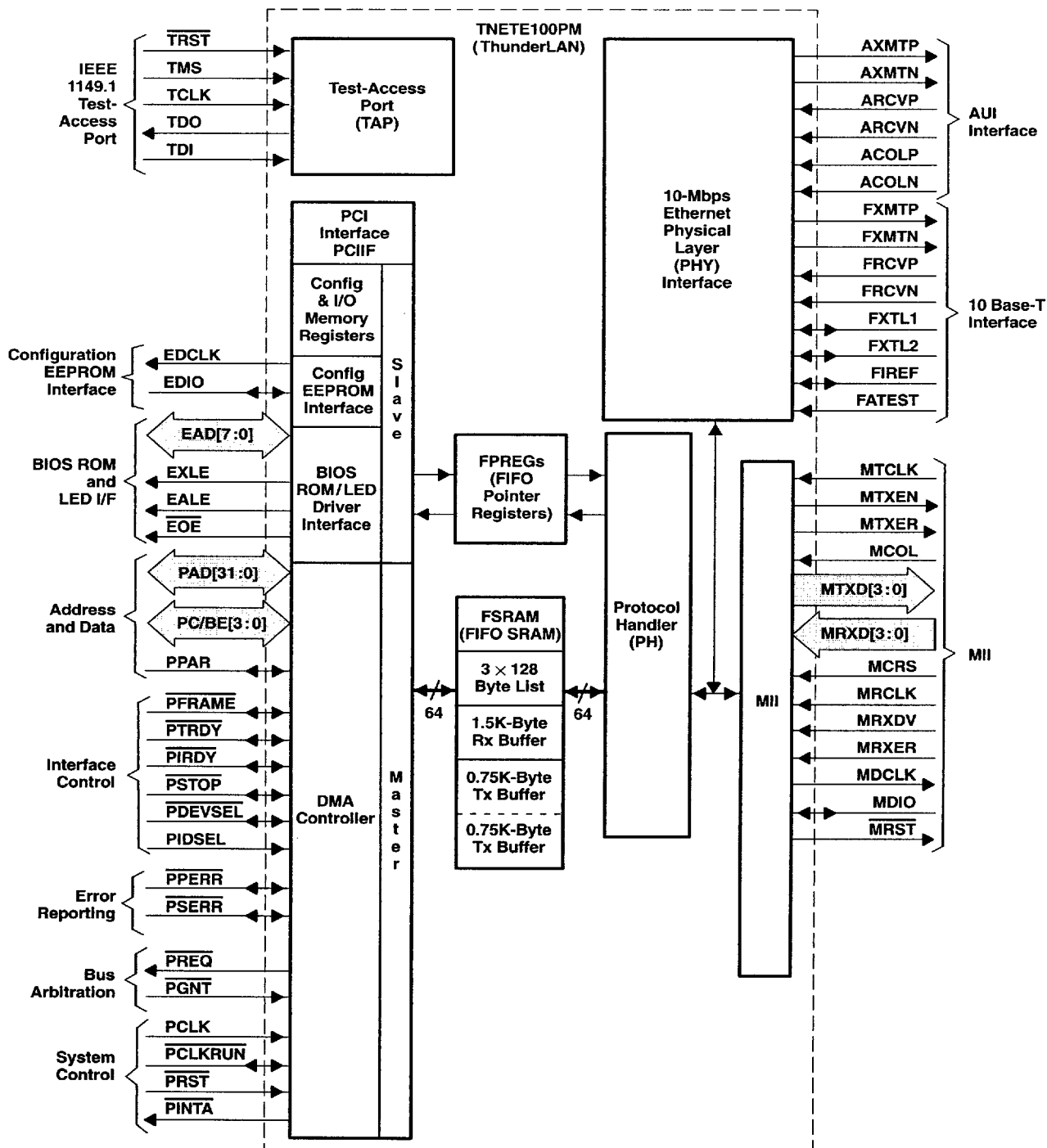
ThunderLAN is the first multimedia-ready architecture and is capable of prioritizing data regardless of the selected protocol. The demand-priority protocol supports two priorities of frames: normal and priority. The two transmit channels provide independent host channels for these two frame types. Carrier-sense multiple access with collision detection (CSMA/CD) protocols only support a single priority of frame, but the two channels can be used to prioritize network access. All received frames pass through the single receive channel.

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functional block diagram

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Pin Functions

PIN NAME	NO.	TYPE†	DESCRIPTION
TEST PORT			
TCLK	124	I	Test clock. TCLK is used to clock state information and test data into and out of the device during operation of the test port.
TDI	126	I	Test data input. TDI is used to shift test data and test instructions serially into the device during operation of the test port.
TDO	125	O	Test data output. TDO is used to shift test data and test instructions serially out of the device during operation of the test port.
TMS	123	I	Test mode select. TMS is used to control the state of the test port controller within TNETE100PM.
TRST	121	I	Test reset. TRST is used for asynchronous reset of the test port controller.
PCI INTERFACE			
PAD31	135	I/O	PCI address/data bus. Byte 3 (most significant) of the PCI address/data bus
PAD30	137		
PAD29	138		
PAD28	140		
PAD27	141		
PAD26	143		
PAD25	144		
PAD24	1		
PAD23	5	I/O	PCI address/data bus. Byte 2 of the PCI address/data bus
PAD22	7		
PAD21	8		
PAD20	9		
PAD19	11		
PAD18	12		
PAD17	13		
PAD16	15		
PAD15	29	I/O	PCI address/data bus. Byte 1 of the PCI address/data bus
PAD14	30		
PAD13	32		
PAD12	33		
PAD11	35		
PAD10	36		
PAD9	38		
PAD8	39		
PAD7	42	I/O	PCI address/data bus. Byte 0 (least significant) of the PCI address/data bus
PAD6	43		
PAD5	45		
PAD4	46		
PAD3	47		
PAD2	49		
PAD1	50		
PAD0	51		

† I = input, O = output, I/O = 3-state input/output

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Pin Functions (Continued)

PIN NAME	NO.	TYPE†	DESCRIPTION
PCI INTERFACE (CONTINUED)			
PCLK	131	I	PCI clock. PCLK is the clock reference for all PCI bus operations. All other PCI pins except \overline{PRST} and \overline{PINTA} are sampled on the rising edge of PCLK. All PCI bus timing parameters are defined with respect to this edge.
$\overline{PCLKRUN}$	53	I/O‡	<p>Clock run control. Powerdown-enable-configuration. The $\overline{PCLKRUN}$ pin must be connected to the \overline{PRST} signal for the system. This reset is generated by the V_{DDI} supply and, therefore, is used to put the TNETE100PM into D3off mode when $SOPD = 1$. When the $\overline{PCLKRUN}$ pin is asserted low, the TNETE100PM performs the following internal functions:</p> <ul style="list-style-type: none"> Disables PCLK during sleep state Puts all PCI outputs in high impedance mode asynchronously Disables $\overline{PFRAME\#}$ to ensure that the TNETE100PM is signaled that it is doing a PCI I/O cycle Resets all TNETE100PM internal state machines Disables all interrupts Sets PowerState = 11b (only if $SOPD = 1$) Stops the transmitter and receiver (destructive) <p>NOTE: Ten PCLK cycles are required for the TNETE100PM to terminate PCI operations and reset all state machines after $\overline{PCLKRUN}$ goes low.</p> <p>Clock run control. Clock-run-enable configuration. The $\overline{PCLKRUN}$ pin must be connected to the $\overline{PCLKRUN}$ signal of the system. $\overline{PCLKRUN}$ is the active-low PCI clock request/grant signal that allows the TNETE100PM to indicate when an active PCI clock is required. (This is an open drain.)</p>
PC/BE3 PC/BE2 PC/BE1 PC/BE0	2 16 28 41	I/O	<p>PCI bus command and byte enables: PC/BE3 enables byte 3 (MSbyte) of the PCI address/data bus. PC/BE2 enables byte 2 of PCI address/data bus. PC/BE1 enables byte 1 of PCI address/data bus. PC/BE0 enables byte 0 (LSbyte) of PCI address/data bus.</p>
$\overline{PDEVSEL}$	21	I/O	PCI device select. $\overline{PDEVSEL}$ indicates that the driving device has decoded one of its addresses as the target of the current access. The TNETE100PM drives $\overline{PDEVSEL}$ when it decodes an access to one of its registers. As a bus master, the TNETE100PM monitors $\overline{PDEVSEL}$ to detect accesses to illegal memory addresses.
\overline{PFRAME}	17	I/O	PCI cycle frame. \overline{PFRAME} is driven by the active bus master to indicate the beginning and duration of an access. \overline{PFRAME} is asserted to indicate the start of a bus transaction and remains asserted during the transaction, only being deasserted in the final data phase.
\overline{PGNT}	132	I	PCI bus grant. \overline{PGNT} is asserted by the system arbiter to indicate that the TNETE100PM has been granted control of the PCI bus.
\overline{PIDSEL}	4	I	PCI initialization device select. \overline{PIDSEL} is the chip select for access to PCI configuration registers.
\overline{PINTA}	128	O/D	PCI interrupt. \overline{PINTA} is the interrupt request from the TNETE100PM. PCI interrupts are shared, so this is an open-drain (wired-OR) output.
\overline{PIRDY}	19	I/O	PCI initiator ready. \overline{PIRDY} is driven by the active bus master to indicate that it is ready to complete the current data phase of a transaction. A data phase is not completed until both \overline{PIRDY} and \overline{PTRDY} are sampled asserted. When the TNETE100PM is a bus master, it uses \overline{PIRDY} to align incoming data on reads or outgoing data on writes with its internal RAM-access synchronization (maximum one cycle at the beginning of burst). When the TNETE100PM is a bus slave, it extends the access appropriately until both \overline{PIRDY} and \overline{PTRDY} are asserted.
\overline{PTRDY}	20	I/O	<p>PCI target ready. \overline{PTRDY} is driven by the selected device (bus slave or target) to indicate that it is ready to complete the current data phase of a transaction. A data phase is not completed until both \overline{PIRDY} and \overline{PTRDY} are sampled asserted.</p> <p>ThunderLAN uses \overline{PTRDY} to ensure every direct I/O (DIO) operation is correctly interlocked.</p>
PPAR	27	I/O	PCI parity. PPAR carries even parity across PAD[31:0] and PC/BE[3:0]. It is driven by the TNETE100PM during all address and write cycles as a bus master and during all read cycles as a bus slave.

† I = input, I/O = 3-state input/output, O/D = open-drain output

‡ Open drain

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PIN NAME	NO.	TYPE†	DESCRIPTION
PCI INTERFACE (CONTINUED)			
$\overline{\text{PPERR}}$	24	I/O	PCI parity error. $\overline{\text{PPERR}}$ indicates a data parity error on all PCI transactions except special cycles.
$\overline{\text{PREQ}}$	134	I/O	PCI bus request. $\overline{\text{PREQ}}$ is asserted by the TNETE100PM to request control of the PCI bus. This is not a shared signal.
$\overline{\text{PRST}}$	129	I	<p>PCI reset signal. Power-down-enable configuration. The $\overline{\text{PRST}}$ pin must be connected to a reset signal ($\overline{\text{VAUXGOOD}}$) by the auxiliary power supply. This pin resets the TNETE100PM on initial power up only. When $\overline{\text{PRST}}$ is asserted low, the TNETE100PM performs the following internal functions:</p> <ul style="list-style-type: none"> Resets all TNETE100PM registers and state machines Puts all PCI outputs (and IEEE standard JTAG pins) in high impedance mode asynchronously <p>PCI reset signal. Clock-run-enable configuration. The $\overline{\text{PRST}}$ pin should be connected to the $\overline{\text{PRST}}$ signal for the system. When $\overline{\text{PRST}}$ is asserted low, the TNETE100PM performs the following internal functions:</p> <ul style="list-style-type: none"> Resets TNETE100PM registers and state machines Puts all PCI outputs (and IEEE standard JTAG pins) in high impedance mode asynchronously
$\overline{\text{PSERR}}$	25	O/D	PCI system error. $\overline{\text{PSERR}}$ indicates parity errors or special cycle data parity errors.
$\overline{\text{PSTOP}}$	23	I/O	PCI stop. $\overline{\text{PSTOP}}$ indicates the current target is requesting the master to stop the current transaction.
BIOS ROM/LED DRIVER INTERFACE			
EAD7 EAD6 EAD5 EAD4 EAD3 EAD2 EAD1 EAD0	54 55 56 57 59 60 61 62	I/O	<p>EPROM address/data. EAD[7:0] is a multiplexed byte-bus that is used to address and read data from an external BIOS ROM.</p> <ul style="list-style-type: none"> On the cycle when EXLE is asserted low, EAD[7:0] is driven with the high byte of the address. On the cycle when EALE is asserted low, EAD[7:0] is driven with the low byte of the address. When EOE is asserted, BIOS ROM data should be placed on the bus. <p>These pins also can be used to drive external-status LEDs. Low-current (2–5 mA) LEDs can be connected directly (through appropriate resistors). High-current LEDs can be driven through buffers or from the BIOS ROM address latches.</p>
EALE	65	O	EPROM address latch enable. EALE is driven low to latch the low (least significant) byte of the BIOS ROM address from EAD[0:7].
$\overline{\text{EOE}}$	64	O	EPROM output enable. When $\overline{\text{EOE}}$ is active (low), EAD[0:7] is in the high-impedance mode and the output of the BIOS ROM should be placed on EAD[0:7].
EXLE	66	O	EPROM extended address latch enable. EXLE is driven low to latch the high (most significant) byte of the BIOS ROM address from EAD[0:7].
CONFIGURATION EEPROM INTERFACE			
EDCLK	68	O	EEPROM data clock. EDCLK transfers serial clocked data to the 2K-bit serial EEPROMs (24C02) (see Note 1). EDCLK requires an external pullup for EEPROM operation.
EDIO	69	I/O	EEPROM data I/O. EDIO is the bidirectional serial data/address line to the 2K-bit serial EEPROM (24C02). EDIO requires an external pullup for EEPROM operation. Tying EDIO to ground disables the EEPROM interface and prevents autoconfiguration of the PCI configuration register.
MEDIA-INDEPENDENT INTERFACE (100-Mbps CSMA/CD AND DEMAND PRIORITY)			
MCOL	80	I	<p>Collision sense</p> <ul style="list-style-type: none"> In CSMA/CD mode, assertion of MCOL indicates a network collision. In demand-priority mode, MCOL (active low) is used to acknowledge a transmission request. The TNETE100PM begins frame transmission 50 MTCLK cycles after the assertion (low) of MCOL.

† I = input, O = output, I/O = 3-state input/output, O/D = open-drain output

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Pin Functions (Continued)

PIN NAME	NO.	TYPE†	DESCRIPTION
MEDIA-INDEPENDENT INTERFACE (100-Mbps CSMA/CD AND DEMAND PRIORITY) (CONTINUED)			
MCRS	81	I	Carrier sense. MCRS indicates a frame-carrier signal is being received.
MDCLK	91	O	Management data clock. MDCLK is part of the serial management interface to physical-media independent (PMI)/PHY chip.
MDIO	93	I/O	Management data I/O. MDIO is part of the serial management interface to PMI/PHY chip.
MRCLK	82	I	Receive clock. MRCLK is the receive clock source from the attached PHY and PMI device.
MRST	95	O	MII reset. MRST is the reset signal to the PMI/PHY front-end (active low).
MRXD0	83	I	Receive data. MRXD[3:0] is the nibble-receive data from the physical-media dependent (PMD) front end. In demand-priority mode, ThunderLAN reads the frame priority of incoming frames on these pins on the cycle before assertion of MRXDV (the cycle before frame reception begins). <ul style="list-style-type: none"> MRXD1 indicates the transmission priority of the received frame. A value of zero indicates normal transmission, and a value of one indicates priority transmission. Data on these pins is always synchronous to MRCLK.
MRXD1	85		
MRXD2	86		
MRXD3	87		
MRXDV	89	I	Receive data valid. MRXDV indicates data on MRXD[3:0] is valid.
MRXER	90	I	Receive error. MRXER indicates reception of a coding error on received data.
MTCLK	71	I	Transmit clock. MTCLK is the transmit clock source from the attached PHY and PMI device.
MTXD0	72	O	Transmit data. MTXD[3:0] is the nibble-transmit data from TNETE100PM. When MTXEN is asserted, these pins carry transmit data. In demand-priority mode, the TNETE100PM drives the request state of the controller on these pins when MTXEN is not asserted (frame transmission not in progress). <ul style="list-style-type: none"> MTXD0 asserted indicates the TNETE100PM is requesting frame transmission. MTXD1 indicates the transmission priority required. A value of zero indicates normal transmission, and a value of one indicates high-priority transmission. Data on these pins is always synchronous to MTCLK.
MTXD1	73		
MTXD2	74		
MTXD3	76		
MTXER	78	O	Transmit error. MTXER allows coding errors to be propagated across the MII.
MTXEN	77	O	Transmit enable. MTXEN indicates valid transmit data on MTXD[3:0].
NETWORK INTERFACE (10 Base-T AND AUI)			
ACOLN	111	A	AUI-receive pair. ACOLN and ACOLP are differential line receiver inputs and connect to receive pair through transformer isolation, etc.
ACOLP	109		
ARCVN	108	A	AUI-receive pair. ARCVN and ARCVP are differential line receiver inputs and connect to receive pair through transformer isolation, etc.
ARCVP	106		
AXMTP	99	A	AUI-transmit pair. AXMTP and AXMTN are differential line-transmitter outputs.
AXMTN	100		
FATEST	118	A	Analog test pin. FATEST provides access to the filter of the reference PLL. This pin must be left as a "no connect".
FIREF	116	A	Current reference. FIREF is used to set a current reference for the analog circuitry.
FOONLY	120	A	Front-end only pin. The FOONLY pin should be tied low for systems not requiring the power management capabilities of the TNETE100PM.
FRCVN	105	A	10 Base-T receive pair. FRCVN and FRCVP are differential line-receiver inputs and connect to receive pair through transformer isolation, etc.
FRCVP	103		
FXTL1	113	A	Crystal oscillator pins. FXTL1 is driven from a 20-MHz crystal oscillator module.
FXTL2	114		
FXMTP	97	A	10 Base-T transmit pair. FXMTP and FXMTN are differential line-transmitter outputs.
FXMTN	98		

† I = input, O = output, A = Analog

NOTE 1: This pin should be tied to V_{DD} with a 4.7-k Ω – 10-k Ω pullup resistor.

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Pin Functions (Continued)

PIN NAME	NO.	TYPE†	DESCRIPTION
POWER			
V _{DDI}	6, 14, 34, 48, 122, 136, 142	PWR	<p>PCI V_{DD} pins. Power-down-enable configuration V_{DDI} pins provide power for the PCI I/O pin drivers. Connect V_{DDI} pins to a 5-V power supply when using 5-V signals on the PCI bus. Connect V_{DDI} pins to a 3-V power supply when using 3-V signals on the PCI bus. Pin #122 should be connected to a power supply that is not powered down during SLEEP mode. This supply must be the same voltage as V_{DDI} when the PCI bus is fully functional.</p> <p>PCI V_{DD} pins. Clock-run-enable configuration V_{DDI} pins provide power for the PCI I/O pin drivers. Connect V_{DDI} pins to a 5-V power supply when using 5-V signals on the PCI bus. Connect V_{DDI} pins to a 3-V power supply when using 3-V signals on the PCI bus.</p>
V _{DDL}	22, 37, 58, 70, 79, 84, 94, 130	PWR	<p>Logic V_{DD} pins (5 V). Power-down-enable configuration V_{DDL} pins provide power for internal TNETE100PM logic and must be connected to an auxiliary power source (5 V).</p> <p>Logic V_{DD} pins (5 V). Clock-run-enable configuration V_{DDL} pins provide power for internal TNETE100PM logic and always must be connected to 5 V.</p>
V _{DDOSC}	115	PWR	Analog power pin. V _{DDOSC} is the 5-V power for the crystal oscillator circuit.
V _{DDR}	104 107	PWR	Analog power pin. V _{DDR} is the 5-V power for the receiver circuitry.
V _{DDT}	96	PWR	Analog power pin. V _{DDT} is the 5-V power for the transmitter circuitry.
V _{DDVCO}	117	PWR	Analog power pin. V _{DDVCO} is the 5-V power for the voltage controller oscillator (VCO) and filter input.
V _{SSI}	3, 10, 26, 31, 40, 52, 67, 88, 127, 139	PWR	PCI I/O ground pins
V _{SSL}	18, 44, 63, 75, 92, 133	PWR	Logic ground pins
V _{SSOSC}	112	PWR	Analog power pin. Ground for crystal oscillator circuit
V _{SSR}	102 110	PWR	Analog power pin. Ground for receiver circuitry
V _{SST}	101	PWR	Analog power pin. Ground for transmitter circuitry
V _{SSVCO}	119	PWR	Analog power pin. Ground for VCO and filter input

† PWR = power

architecture

The major blocks of the TNETE100PM include the PCI interface (PCIIF), protocol handler(PH), media independent interface (MII), physical layer (PHY), FIFO pointer registers (FPREGS), FIFO SRAM (FSRAM), and a test-access port (TAP). The functionality of these blocks is described in the following sections.

PCI interface (PCIIF)

The TNETE100PM PCIIF contains a byte-aligning DMA controller that allows frames to be fragmented into any byte length and transferred to any byte address while supporting 32-bit data streaming. For multipriority networks, it can provide multiple data channels, each with separate lists, commands, and status. Data for the channels is passed to and from the PH by way of circular buffer FIFOs in the SRAM, controlled through FIFO registers. The configuration EEPROM interface (CEI), BIOS ROM/LED driver interface (BRI), configuration and I/O memory registers (CIOREGS), and DMA controller are subblocks of the PCIIF. The features of these subblocks are described in the following subsections.

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configuration EEPROM interface (CEI)

The CEI provides a means for autoconfiguration of the PCI configuration registers. Certain registers in the PCI configuration space can be loaded using the CEI. Autoconfiguration allows builders of TNETE100PM-based systems to customize the contents of these registers to identify their own system, rather than to use the TI defaults. The EEPROM is read at power up and can then be read from, and written to, under program control.

BIOS ROM/LED driver interface (BRI)

The BRI addresses and reads data from an external BIOS ROM through a multiplexed byte-wide bus. The ROM address/data pins also can be multiplexed to drive external status LEDs.

configuration and I/O memory registers (CIOREGS)

The CIOREGS reside in the configuration space, which is 256 bytes in length. The first 64 bytes of the configuration space comprise the header region, which is defined explicitly by the PCI standard.

DMA controller (DMAC)

The DMAC is responsible for coordinating TNETE100PM requests for mastership of the PCI bus. The DMAC provides byte-aligning DMA control, allowing byte-size fragmented frames to be transferred to any byte address while supporting 32-bit data streaming.

protocol handler (PH)

The PH implements the serial protocols of the network. On transmit, it serializes data, adds framing and CRC fields, and interfaces to the network PHY. On receive, it provides address recognition, CRC and error checking, frame disassembly, and deserialization. Data for multiple channels is passed to and from the PH by way of circular buffer FIFOs in the FSRAM controlled through FPREGS. The PH supports an MII that is compatible with the IEEE 802.12 and IEEE 802.3u logic.

media-independent interface (MII)

The MII provides both MAC-level 100 Base-T (IEEE 802.3u) and 100VG-AnyLAN (IEEE 802.12) controller functions to external PHY chips that handle the PHY functions for 100-Mbps CSMA/CD and demand priority. The MII also is used to communicate with the on-chip 10 Base-T PHY which is located at address 0x1F.

10 Base-T physical layer (PHY)

The PHY acts as an on-chip front-end providing physical layer functions for 10 Base-5 (AUI), 10 Base-2, and 10 Base-T (twisted pair). The PHY provides Manchester encoding/decoding from MII nibble-format data, smart squelch, jabber detection, link pulse detection, autopolarity control, 10 Base-T transmission waveshaping, and antialiasing filtering. Connection to the AUI drop cable for the 10 Base-T twisted pair is made through simple isolation transformers (see Figure 2) and no external filter networks are required. Suitable external termination components allow the use of either shielded or unshielded twisted-pair cable (150 Ω or 100 Ω). Some of the key features of the on-chip PHY are listed as follow:

- Integrated filters
- Integrated MII, including encoder/decoder
- 10 Base-T transceiver
- AUI transceiver
- 10 Base-2 transceiver
- Autopolarity (reverse polarity correction)
- Loopback for twisted pair and AUI
- Full-duplex mode for simultaneous 10 Base-T transmission and reception
- Low power



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10 Base-T physical layer (PHY) (continued)

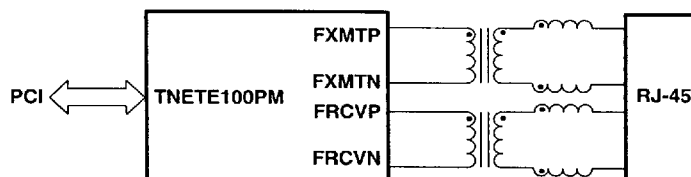


Figure 2. Schematic for 10 Base-T Network Interface Using TNETE100PM

FIFO pointer registers (FPREGS)

The FPREGS are used to implement circular buffer FIFOs in the SRAM. They are a collection of pointer and counter registers used to maintain the FIFO operation. Both the PCIIF and PH use FPREGS to determine where to read or write data in the SRAM and to determine how much data the FIFO contains. Unique receive and transmit FIFO registers are needed for each data channel supported.

FIFO SRAM (FSRAM)

The FSRAM is a conventional SRAM array accessed synchronously to the PCI bus clock. Access to the RAM is allocated on a time-division multiplexed (TDM) basis, rather than through a conventional shared bus. This removes the need for bus arbitration and provides ensured bandwidth. Half of the RAM accesses (every other cycle) are allocated to the PCI controller. It has a 64-bit access port to the RAM, giving it 1 Gbps of bandwidth, sufficient to support 32-bit data streaming on the PCI bus. The PH has one-quarter of the RAM accesses, and its port may be up to 64 bits wide. A 64-bit port for the PH provides 512 Mbps of bandwidth, more than sufficient for a full-duplex 100-Mbps network. The remaining RAM accesses can be allocated toward providing even more PH bandwidth. The RAM is accessible also (for diagnostic purposes) from the TNETE100PM internal data bus. Host DIO (mapped I/O) accesses are used by the host to access internal TNETE100PM registers and for controller test.

Features of the FSRAM include:

- 3.375K bytes of FSRAM
 - 1.5K-byte FIFO for receive
 - Two 0.75K-byte FIFOs for the two transmit channels
 - Three 128-byte lists
- In one-channel mode, the two transmit channels are combined, providing a single 1.5K-byte FIFO for a single transmit channel.

Supporting 1.5K bytes of FIFO per channel allows full-frame buffering of Ethernet frames. PCI latency is such that a minimum of 500 bytes of storage is required to support 100-Mbps LANs.

test-access port (TAP)

Compliant with IEEE Standard 1149.1, the TAP is composed of five pins that are used to interface serially with the device and the board on which it is installed for boundary-scan testing.

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absolute maximum ratings over operating case temperature range (unless otherwise noted)†

Supply voltage range, V_{DD} (see Note 2)	– 0.5 V to 7 V
Input voltage range (see Note 2)	– 0.5 V to 7 V
Output voltage range	– 0.5 V to 7 V
Power dissipation	TBD
Operating case temperature range, T_C	0°C to 95°C
Storage temperature range, T_{stg}	– 65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 2: Voltage values are with respect to V_{SS} , and all V_{SS} pins should be routed so as to minimize inductance to system ground.

The recommended operating conditions and the electrical characteristics tables are divided into groups, depending on pin function:

- PCI-interface pins
- Logic pins
- Physical-layer pins

The PCI signal pins are operated in one of two modes shown in the PCI tables.

- 5-V signal mode
- 3-V signal mode

recommended operating conditions (PCI-interface pins only) (see Note 3)

		3-V SIGNALING OPERATION			5-V SIGNALING OPERATION			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{DD}	Supply voltage (PCI)	3	3.3	3.6	4.75	5	5.25	V
V_{IH}	High-level input voltage	$0.5 \times V_{DD}$		$V_{DD} + 0.5$	2.0	$V_{DD} + 0.5$		V
V_{IL}	Low-level input voltage, TTL-level signal (see Note 4)	– 0.5	$0.3 \times V_{DD}$		– 0.5	0.8		V
I_{OH}	High-level output current	TTL outputs		– 0.5	TTL outputs		– 2	mA
I_{OL}	Low-level output current (see Note 5)	TTL outputs		1.5	TTL outputs		6	mA
T_C	Operating case temperature	0		95	0		95	°C
T_{stg}	Storage temperature	– 65		150	– 65		150	°C

- NOTES: 3. PCI interface pins include $PCLKRUN$, $PFRAME$, $PTRDY$, $PIRDY$, $PSTOP$, $PDEVSEL$, $PIDSEL$, $PPERR$, $PSERR$, $PREQ$, $PGNT$, $PCLK$, $PPAR$, $PRST$, $PINTA$, $PAD[31:0]$, and $PC/BE[3:0]$.
4. The algebraic convention, where the more negative (less positive) limit is designated as a minimum, is used for logic-voltage levels only.
5. Output current of 2 mA is sufficient to drive five low-power Schottky TTL loads or ten advanced low-power Schottky TTL loads (worst case).



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**electrical characteristics over recommended ranges of supply voltage (unless otherwise noted)
(PCI-interface pins)**

PARAMETER		TEST CONDITIONS †		3-V SIGNALING OPERATION		5-V SIGNALING OPERATION		UNIT
				MIN	MAX	MIN	MAX	
V _{OH}	High-level output voltage, TTL-level signal (see Note 6)	V _{DD} = MIN,	I _{OH} = MAX	0.9 × V _{DD}		2.4		V
V _{OL}	Low-level output voltage, TTL-level signal	V _{DD} = MAX,	I _{OL} = MAX	0.1 × V _{DD}		0.55		V
I _{OZ}	High-impedance output current	V _{DD} = MAX,	V _O = 0 V	10		10		μA
		V _{DD} = MAX,	V _O = V _{DD}	– 10		– 10		
I _I	Input current, any input or input/output	V _I = V _{SS} to V _{DD}		± 10		± 70		μA
I _{DD}	Supply current	V _{DD} = MAX		50		60		mA
C _i	Input capacitance, any input	f = 1 MHz,	Others at 0 V	10		10		pF
C _O	Output capacitance, any output or input/output	f = 1 MHz,	Others at 0 V	10		10		pF

† For conditions shown as MIN/MAX, use the appropriate value specified under the recommended operating conditions.

NOTE 6: The following signals require an external pullup resistor: PSERR, PINTA.

recommended operating conditions (logic pins) (see Note 7)

		MIN	NOM	MAX	UNIT
V _{DD}	Supply voltage (5 V only)	4.75	5	5.25	V
V _{IH}	High-level input voltage	2		V _{DD} +0.3	V
V _{IL}	Low-level input voltage, TTL-level signal (see Note 4)	–0.3		0.8	V
I _{OH}	High-level output current	TTL outputs		–4	mA
I _{OL}	Low-level output current (see Note 5)	TTL outputs		4	mA

- NOTES: 4. The algebraic convention, where the more negative (less positive) limit is designated as a minimum, is used for logic-voltage levels only.
5. Output current of 2 mA is sufficient to drive five low-power Schottky TTL loads or ten advanced low-power Schottky TTL loads (worst case).
7. Logic pins include V_{DDL}, EAD[7:0], EXLE, EALE, $\overline{\text{EOE}}$, EDCLK, EDIO, FONLY, MTCLK, MTXEN, MTXER, MCOL, MTXD[3:0], MRXD[3:0], MCRS, MRCLK, MRXDV, MRXER, MDCLK, MDIO, MRST.

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electrical characteristics over recommended ranges of supply voltage (unless otherwise noted)
(logic pins)

PARAMETER	TEST CONDITIONS†	MIN	NOM	MAX	UNIT
V _{OH} High-level output voltage, TTL-level signal	V _{DD} = MIN, I _{OH} = MAX	2.4			V
V _{OL} Low-level output voltage, TTL-level signal	V _{DD} = MAX, I _{OL} = MAX			0.5	V
I _O High-impedance output current	V _{DD} = MIN, V _O = V _{DD}			10	μA
	V _{DD} = MIN, V _O = 0 V			-10	μA
I _I Input current	V _I = V _{SS} to V _{DD}			± 10	μA
I _{DD} Supply current 33 MHz (PCLK) (see Note 8)	V _{DD} = NOM		243		mA
I _{DD} (RESET) Device reset (idle)			178		
I _{DD} (SLEEP) Sleep mode			51‡		
I _{DD} (RWAKE) Remote wake up			186§		
I _{DD} (PWRDN) Power down			51		
C _i Input capacitance, any input¶	f = 1 MHz, Others at 0 V			10	pF
C _o Output capacitance, any output or input/output¶	f = 1 MHz, Others at 0 V			10	pF

† Refer to the recommended operating conditions

‡ PCLK stopped

§ MTCLK stopped

¶ Specified by design

NOTE 8: More information on each mode is available in the ThunderLAN Power Management and Remote Wake-Up Specification.

recommended operating conditions (physical-layer pins) (see Note 9)

	JEDEC SYMBOL	MIN	NOM	MAX	UNIT
V _{DD} Supply voltage		4.75	5	5.25	V

NOTE 9: Physical-layer pins include V_{DDOSC}, V_{DDR}, V_{DDT}, V_{DDVCO}, ACOLN, ACOLP, ARCVN, ARCVP, AXMTP, AXMTN, FATEST, FIREF, FRCVN, FRCVP, FXTL1, FXTL2, FXMTP, and FXMTN.

electrical characteristics over recommended ranges of supply voltage (unless otherwise noted)
(physical-interface pins)

10 Base-T receiver input (FRCVP, FRCVN)

PARAMETER	JEDEC SYMBOL	TEST CONDITIONS	MIN	MAX	UNIT
V _I (DIFF) Differential input voltage†	V _{ID}		0.6	2.8	V
I _(CM) Common-mode current†	I _{IC}			4	mA
V _{SQ+} Rising input pair squelch threshold (see Note 10)		V _{CM} = V _{SB} , See Note 11		270	mV
V _{SQ-} Falling input pair squelch threshold		V _{CM} = V _{SB} , See Note 11	-270		mV

† Refer to the recommended operating conditions

NOTES: 10. V_{SB} is the self-bias voltage of the input pair FRCVP and FRCVN.

11. V_{SQ} is the voltage level at which input is ensured to be seen as data.



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electrical characteristics over recommended ranges of supply voltage (unless otherwise noted)
(physical-interface pins) (continued)

10 Base-T transmitter drive characteristics (FXMTP, FXMTN)

PARAMETER	JEDEC SYMBOL	TEST CONDITIONS	MIN	MAX	UNIT
V _{SLW} Differential voltage at specified slew rate	V _{OD(SLEW)}		±2.2	±2.8	V
V _{O(CM)} Common-mode output voltage	V _{OC}	See Figure 3d	0	4	V
V _{O(DIFF)} Differential voltage output	V _{OD}	Into open circuit		5.25	V
V _{O(I)} Output idle differential voltage	V _{OD(IDLE)}			±50	mV
I _{O(FC)} Output current, fault condition†	I _{O(FC)}			300	mA

† Specified by design

AUI-receiver input (ARCVP, ARCVN, ACOLP, ACOLN)

PARAMETER	JEDEC SYMBOL	TEST CONDITIONS	MIN	MAX	UNIT
V _{I(DIFF)1} Differential input voltage 1‡	V _{ID(1)}	See Note 12	0	3	V
V _{I(DIFF)2} Differential input voltage 2‡	V _{ID(2)}	See Note 13	0	100	mV
V _(SQ) Falling input pair squelch threshold			-325		mV

‡ Refer to recommended operating conditions

NOTES: 12. Common-mode frequency range : 0 Hz to 40 kHz

13. Common-mode frequency range : 40 kHz to 10 MHz

AUI-transmitter drive characteristics (AXMTP, AXMTN)

PARAMETER	JEDEC SYMBOL	TEST CONDITIONS	MIN	MAX	UNIT
V _{O(DIFF)1} Differential output voltage	V _{OD(1)}	See Note 14	±500	±1315	mV
V _{O(I)DIFF} Output idle differential voltage‡	V _{OD(IDLE)}			±40	mV
V _{O(I)DIFF} U Output differential undershoot§	V _{OD(IDLE)U}			100	mV
I _{O(FC)} Output current, fault condition§	I _{O(FC)}			150	mA

‡ Refer to recommended operating conditions

§ Characterized but not tested

NOTE 14: The differential voltage is measured as per Figure 3b.

crystal-oscillator characteristics

PARAMETER	JEDEC SYMBOL	TEST CONDITIONS	MIN	MAX	UNIT
V _{SB(FXTL1)} Input self-bias voltage	V _{IB}		1.7	2.8	V
I _{OH(FXTL2)} High-level output current (see Note 4)	I _{OH}	V _(FXTL2) = V _{SB(FXTL1)} V _(FXTL1) = V _{SB(FXTL1)} + 0.5 V	-1.3	-5.0	mA
I _{OL(FXTL2)} Low-level output current	I _{OL}	V _(FXTL2) = V _{SB(FXTL1)} V _(FXTL1) = V _{SB(FXTL1)} - 0.5 V	0.4	1.3	mA

NOTE 4: The algebraic convention, where the more negative (less positive) limit is designated as a minimum, is used for logic-voltage levels only.

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**TEXAS
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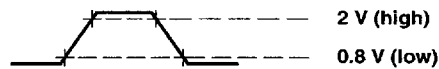
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PARAMETER MEASUREMENT INFORMATION

Outputs are driven to a minimum high-logic level of 2.4 V and to a maximum low-logic level of 0.6 V. These levels are compatible with TTL devices.

Output transition times are specified as follows: For a high-to-low transition on either an input or output signal, the level at which the signal is said to be no longer high is 2 V and the level at which the signal is said to be low is 0.8 V. For a low-to-high transition, the level at which the signal is said to be no longer low is 0.8 V and the level at which the signal is said to be high is 2 V, as shown below.

The rise and fall times are not specified but are assumed to be those of standard TTL devices, which are typically 1.5 ns.

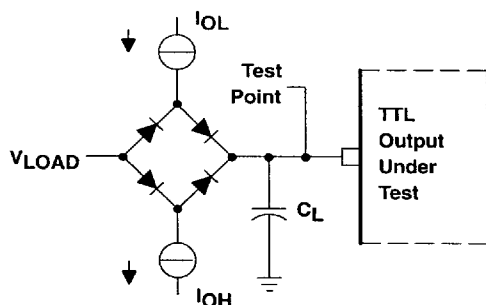


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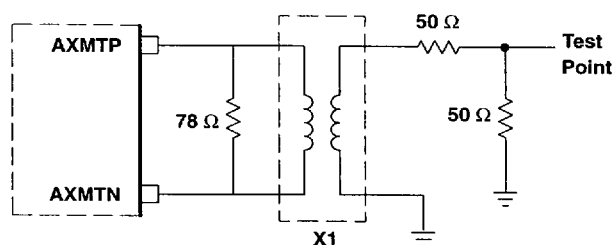
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test measurement

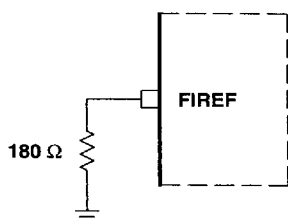
The test-load circuit shown in Figure 3 represents the programmable load of the tester pin electronics that are used to verify timing parameters of the TNETE100PM output signals.



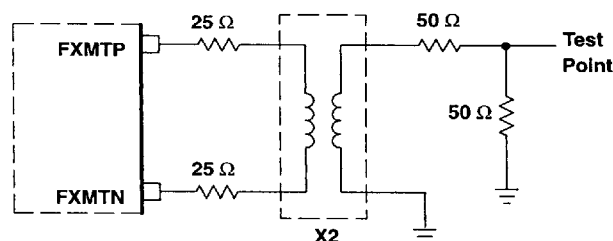
(a) TTL OUTPUT TEST LOAD



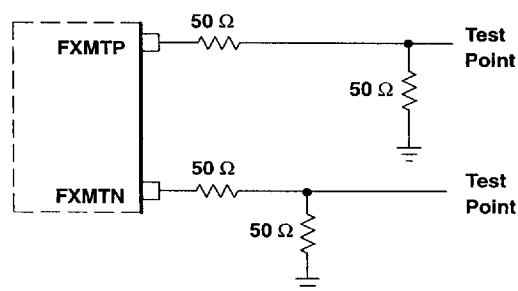
(b) AXMTP AND AXMTN TEST LOAD (ac TESTING)
X1 – Fil – Mag 23Z90 (1:1)



(c) FIREF TEST CIRCUIT



(d) FXMTP AND FXMTN TEST LOAD (ac TESTING)
X2 – Fil – Mag 23Z128 (1:√2)



(e) FXMTP AND FXMTN TEST LOAD (dc TESTING)

Where: I_{OL} = Refer to I_{OL} in recommended operating conditions
 I_{OH} = Refer to I_{OH} in recommended operating conditions
 V_{LOAD} = 1.5 V, typical dc-level verification or
0.7 V, typical timing verification
 C_L = 18 pF, typical load-circuit capacitance

Figure 3. Test and Load Circuit

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switching characteristics for 5-V and 3.3-V PCI (see Note 15 and Figure 4)

PARAMETER		MIN	MAX	UNIT
t _{VAL}	Delay time, PCLK to bused signals valid (see Notes 16 and 17)	2	11	ns
t _{VAL(PTP)}	Delay time, PCLK to bused signals valid point-to-point (see Notes 16 and 17)	2	12	ns
t _{on}	Float to active delay	2		ns
t _{off}	Active to float delay		28	ns

- NOTES: 15. Some of the timing symbols in this table are not currently listed with EIA or JEDEC standards for semiconductor symbology but are consistent with the PCI Local-Bus Specification, Revision 2.0.
16. Minimum times are measured with a 0-pF equivalent load; maximum times are measured with a 50-pF equivalent load. Actual test capacitance may vary, but results should be correlated to these specifications.
17. $\overline{\text{PREQ}}$ and $\overline{\text{PGNT}}$ are point-to-point signals and have different output-valid delay and input-setup times than do bused signals. $\overline{\text{PGNT}}$ has a setup time of 10 ns; $\overline{\text{PREQ}}$ has a setup time of 12 ns. All other signals are bused.

timing requirements for 5-V and 3.3-V PCI (see Note 15 and Figure 4)

		MIN	MAX	UNIT
t _{SU}	Setup time, bused signals valid to PCLK (see Note 17)	7		ns
t _{SU(PTP)}	Setup time to PCLK—point-to-point (see Note 17)	10, 12		ns
t _H	Input hold time from PCLK	0		ns
t _C	Cycle time, PCLK (see Note 18)		100 Mbps	ns
			10 Mbps	ns
t _{W(H)}	Pulse duration, PCLK high	11		ns
t _{W(L)}	Pulse duration, PCLK low	11		ns
t _{SLEW}	Slew rate, PCLK (see Note 19)	1	4	V/ns

- NOTES: 15. Some of the timing symbols in this table are not currently listed with EIA or JEDEC standards for semiconductor symbology but are consistent with the PCI Local-Bus Specification, Revision 2.0.
17. $\overline{\text{PREQ}}$ and $\overline{\text{PGNT}}$ are point-to-point signals and have different output-valid delay and input-setup times than do bused signals. $\overline{\text{PGNT}}$ has a setup time of 10 ns; $\overline{\text{PREQ}}$ has a setup time of 12 ns. All other signals are bused.
18. As a requirement for frame transmission/reception, the minimum PCLK frequency varies with network speed. The clock may be stopped only in a low state.
19. Rise and fall times are specified in terms of the edge rate measured in V/ns. This slew rate must be met across the minimum peak-to-peak portion of the clock waveform.

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timing requirements for 5-V and 3.3-V PCI (see Note 15 and Figure 4) (continued)

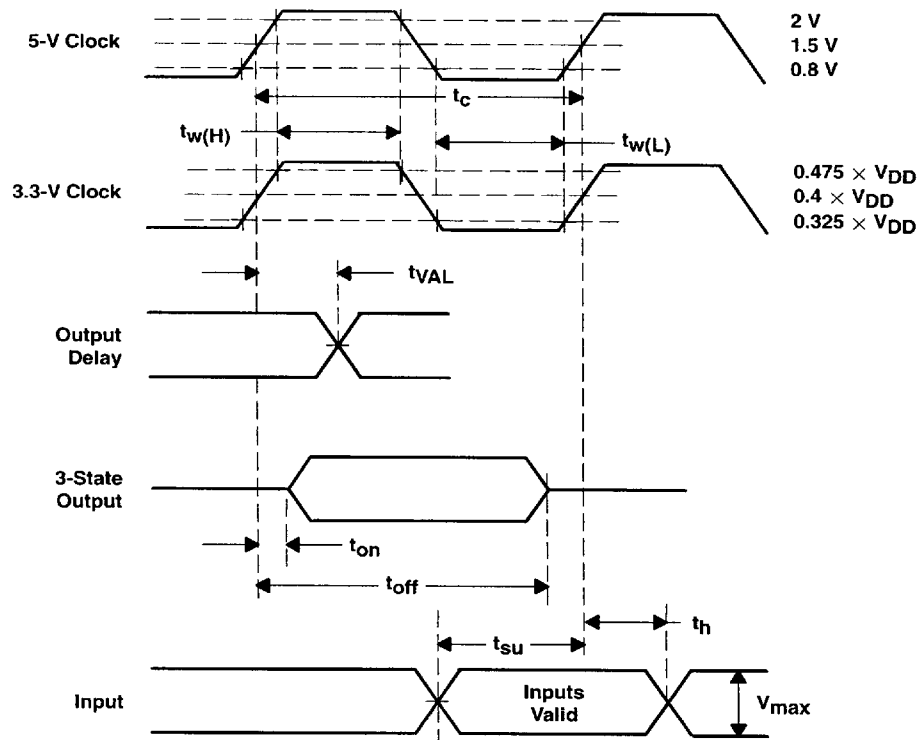


Figure 4. 5-V and 3.3-V PCI Timing

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timing requirements for MII receive (see Figure 5)†

		MIN	MAX	UNIT
$t_{su}(\text{MRX pins})$	Setup time, MRXD[3:0], MRXDV, MRXER (see Note 20)	10		ns
$t_h(\text{MRX pins})$	Hold time, MRXD[3:0], MRXDV, MRXER (see Note 20)	10		ns

switching characteristics for MII transmit (see Figure 5)†

PARAMETER		MIN	MAX	UNIT
$t_d(\text{MTX pins})$	Delay time, MTCLK to MTXD[3:0], MTXEN, and MTXER outputs (see Note 21)	0	25	ns

† Both MCRS and MCOL are driven asynchronously by the PHY.

NOTES: 20. MRXD[3:0] is driven by the PHY on the falling edge of MRCLK. It is sampled by the reconciliation sublayer synchronous to the edge of MRCLK. MRXD[3:0] timing must be met during clock periods where MRXDV is asserted. MRXDV is asserted and deasserted by the PHY on the falling edge of MRCLK. It is sampled by the reconciliation sublayer synchronous to the rising edge of MRCLK. MRXER is driven by the PHY on the falling edge of MRCLK. It is sampled by the reconciliation sublayer synchronous to the rising edge of MRCLK. MRXER timing must be met during clock periods when MRXDV is asserted.

21. MTXD[3:0] is driven by the reconciliation sublayer synchronous to the MTCLK. MTXEN is asserted and deasserted by the reconciliation sublayer synchronous to the MTCLK rising edge. MTXER is driven synchronous to the rising edge of MTCLK.

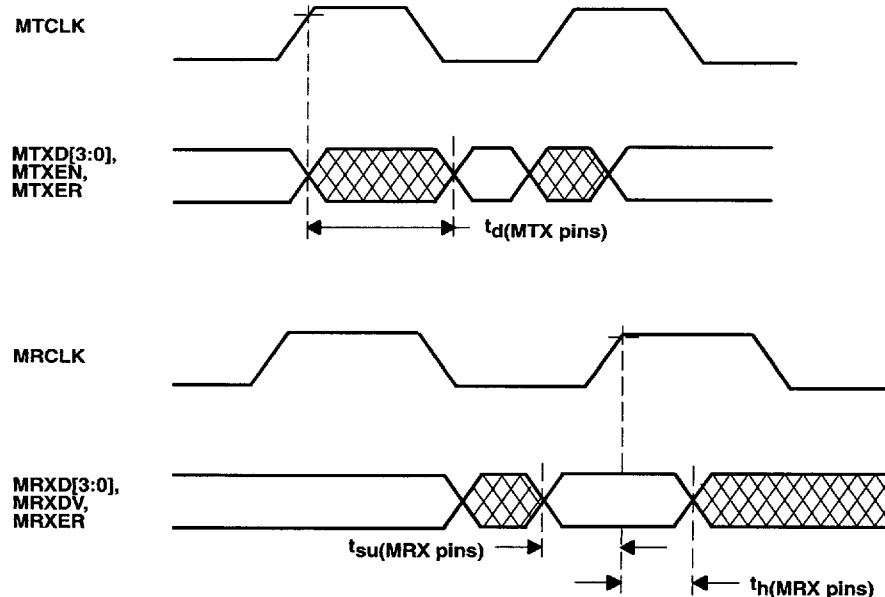


Figure 5. MII Transmit and Receive Timing

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timing requirements for management data I/O (MDIO) (see Figure 6)

	MIN	MAX	UNIT
$t_a(\text{MDCLKH-MDIOV})$ Access time, MDIO valid from MDCLK high (see Note 22)	0	300	ns

switching characteristics for management data I/O (MDIO) (see Figure 7)

PARAMETER	MIN	MAX	UNIT
$t_d(\text{MDIOV-MDCLKH})$ Delay time, MDIO valid to MDCLK high (see Note 23)	10		ns
$t_d(\text{MDCLKH-MDIOX})$ Delay time, MDCLK high to MDIO changing (see Note 23)	10		ns

NOTES: 22. When the MDIO signal is sourced by the PMI/PHY, it is sampled by TNETE100PM synchronous to the rising edge of MDCLK.

23. MDIO is a bidirectional signal that can be sourced by TNETE100PM or the PMI/PHY. When TNETE100PM sources the MDIO signal, TNETE100PM asserts MDIO synchronous to the rising edge of MDCLK.

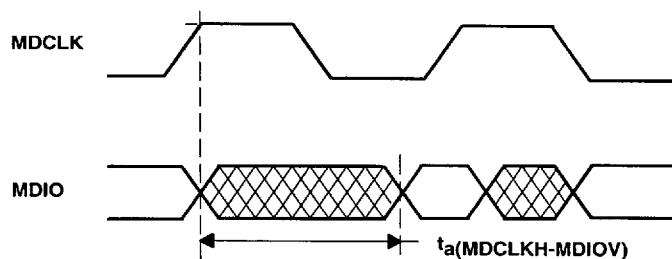


Figure 6. Management Data I/O Timing (Sourced by PHY)

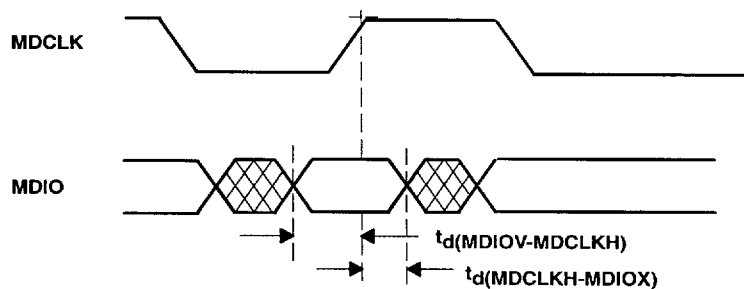


Figure 7. Management Data I/O Timing (Sourced by TNETE100PM)

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timing requirements for BIOS ROM and LED interface (see Figure 8)†

	MIN	MAX	UNIT
t_{su} Setup time, data		250	ns
t_h Hold time, data	0		ns

† The EPROM interface, consisting of 11 pins, requires only two TTL '373 latches to latch the high and low addresses.

switching characteristics for BIOS ROM and LED interface (see Figure 8)†

PARAMETER	MIN	MAX	UNIT
$t_d(\text{EADV-EXLE})$ Delay time, address high byte valid to EXLE low (address high byte setup time for external latch)	0		ns
$t_d(\text{EXLEL-EADZ})$ Delay time, EXLE low to address high byte invalid (address high byte hold time for external latch)	10		ns
$t_d(\text{EADV-EALEL})$ Delay time, address low byte valid to EALE low (address low byte setup time for external latch)	0		ns
$t_d(\text{EALEL-EADZ})$ Delay time, EALE low to address low byte invalid (address low byte hold time for external latch)	10		ns
t_a Access time, address	288		ns

† The EPROM interface, consisting of 11 pins, requires only two TTL '373 latches to latch the high and low addresses.

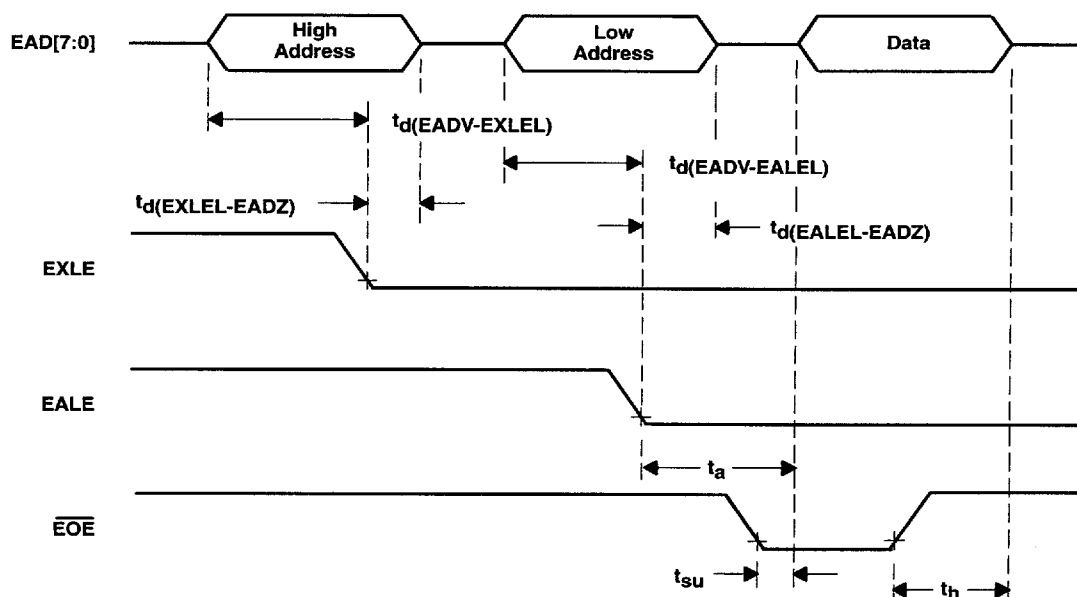


Figure 8. BIOS ROM and LED Interface Timing

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8961724 0110200 375

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switching characteristics for configuration EEPROM interface (see Figure 9)

PARAMETER		MIN	MAX	UNIT
$f_{CLK}(EDCLK)$	Clock frequency, EDCLK	0	100	kHz
$t_d(EDCLKL-EDIOV)$	EDCLK low to EDIO data in valid	0.3	3.5	μs
$t_d(EDIO \text{ free})$	Time the bus must be free before a new transmission can start	4.7		μs
$t_d(EDIOV-EDCLKL)$	Delay time, EDIO valid after EDCLK low (start condition hold time for EEPROM)	4		μs
$t_w(L)$	Low period, clock	4.7		μs
$t_w(H)$	High period, clock	4		μs
$t_d(EDCLKH-EDIOV)$	Delay time, EDCLK high to EDIO valid (start condition setup time)	4.7		μs
$t_d(EDCLKL-EDIOX)$	Delay time, EDCLK low to EDIO changing (data out hold time)	0		μs
$t_d(EDIOV-EDCLKH)$	Delay time, EDIO valid to EDCLK high (data out setup time)	250		ns
t_r	Rise time, EDIO and EDCLK		1	μs
t_f	Fall time, EDIO and EDCLK		300	ns
$t_d(EDCLKH-EDIOH)$	Delay time, EDCLK high to EDIO high (stop condition setup time)	4.7		μs
$t_d(EDCLKL-EDIOX)$	Delay time, EDCLK low to EDIO changing (data in hold time)	300		ns

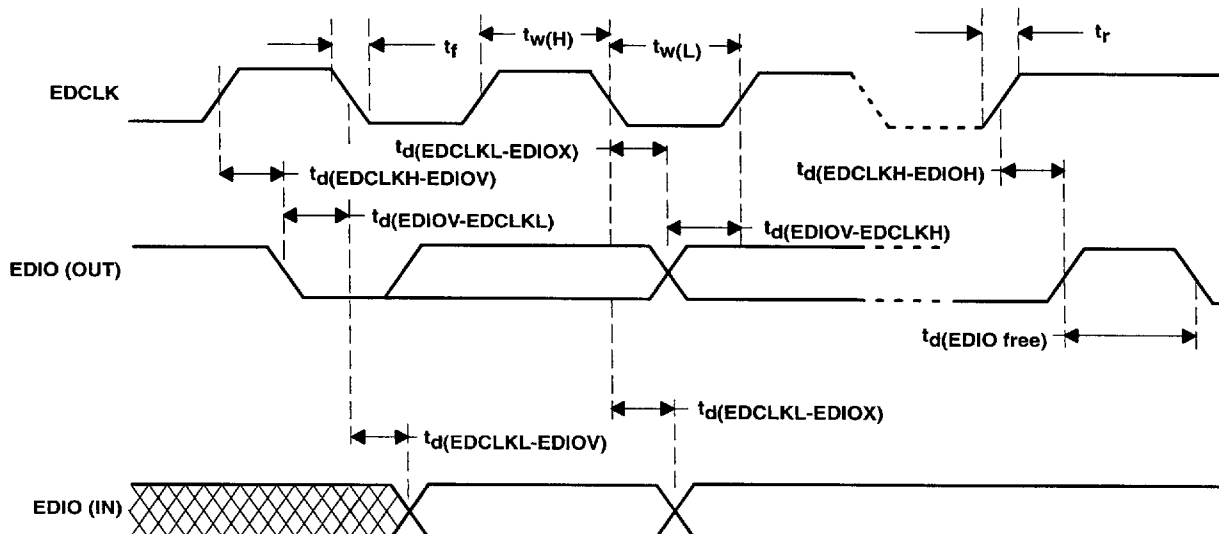


Figure 9. Configuration EEPROM Interface Timing

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timing requirements for crystal oscillator (see Figure 10)†

		MIN	TYP	MAX	UNIT
$t_d(V_{DDH}-FXTL1V)$	Delay time from minimum V_{DD} high level to first valid FXTL1 full swing period			100	ms
$t_w(H)$	Pulse duration at FXTL1 high	13			ns
$t_w(L)$	Pulse duration at FXTL1 low	13			ns
t_t	Transition time of FXTL1		7		ns
t_c	Cycle time, FXTL1		50		ns
	Tolerance of FXTL1 input frequency		± 0.01		%

† The FXTL signal can be driven either by a 20-MHz crystal using the FXTL1 and FXTL2 pins or by a 20-MHz crystal oscillator driving the FXTL1 pin.

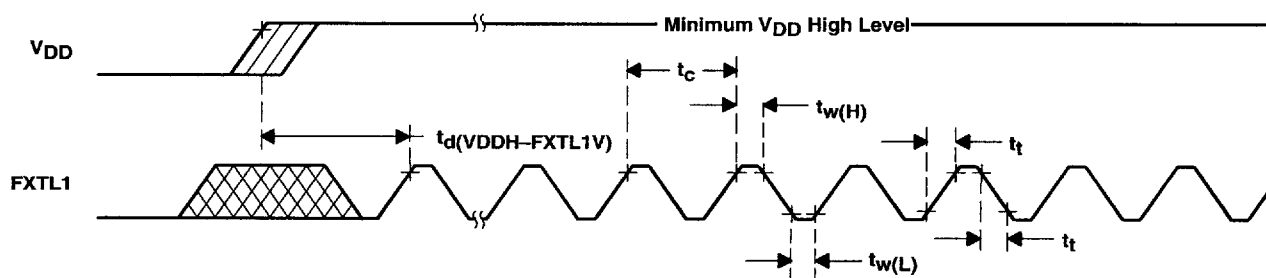


Figure 10. Crystal-Oscillator Timing

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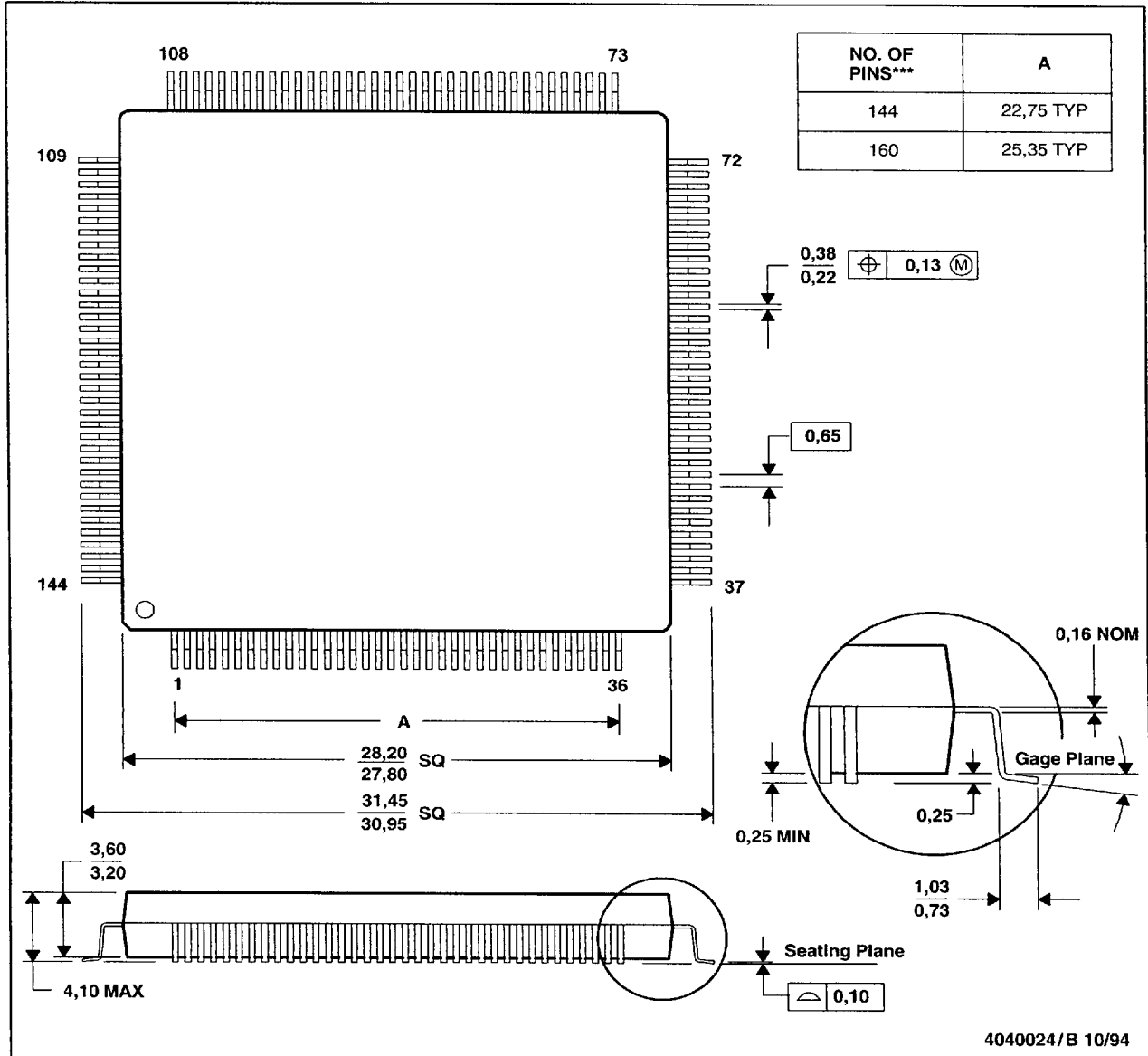
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MECHANICAL DATA

PCM (S-PQFP-G***)

144 PIN SHOWN

PLASTIC QUAD FLATPACK



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Falls within JEDEC MS-022
 - D. The 144 PCM is identical to the 160 PCM except that four leads per corner are removed.



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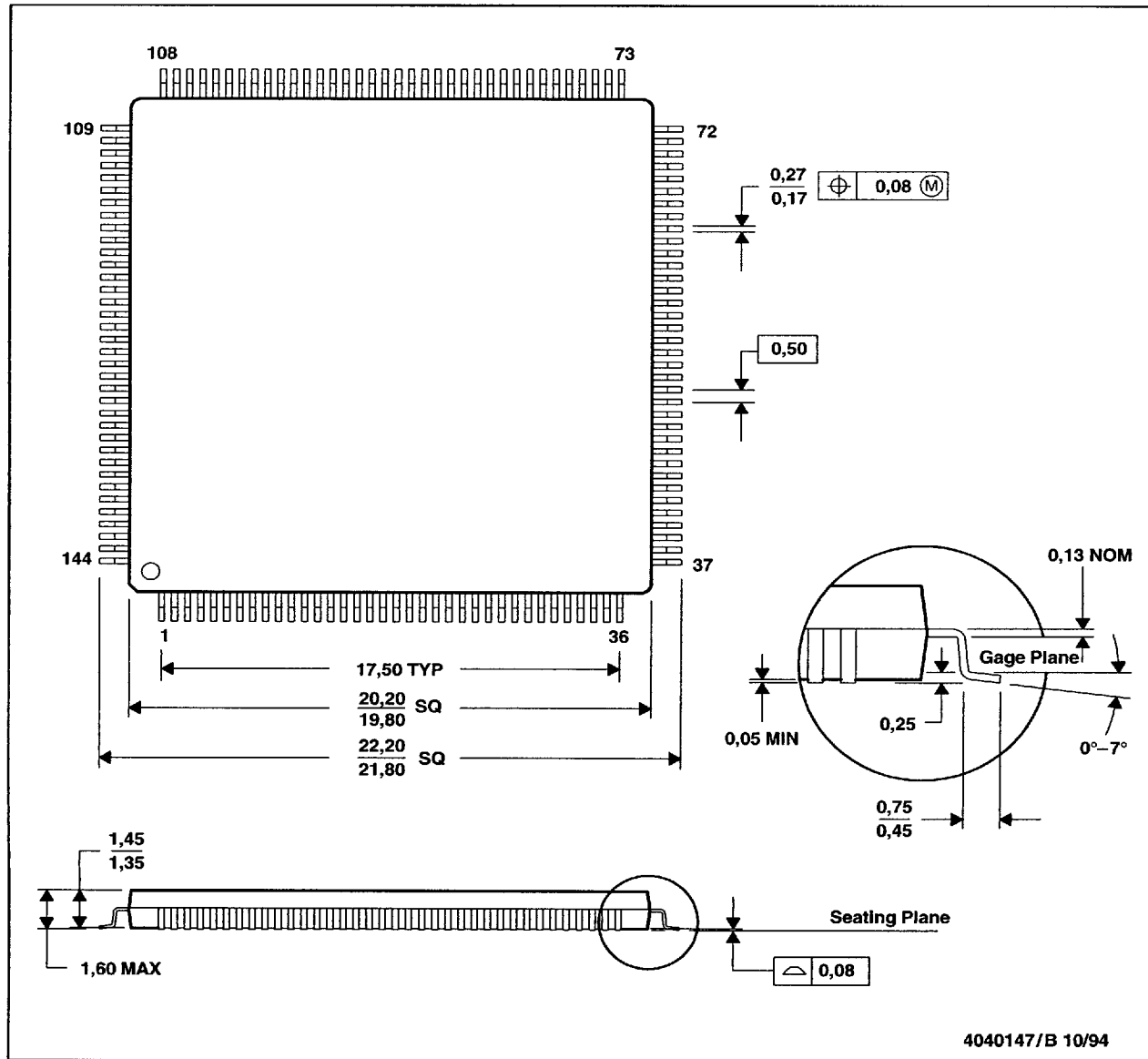
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MECHANICAL DATA

PGE (S-PQFP-G144)

PLASTIC QUAD FLATPACK

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- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Falls within JEDEC MO-136



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